

STARPOWER

SEMICONDUCTOR

IGBT

GD15PJA120L2SM

1200V/15A PIM in one-package

General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

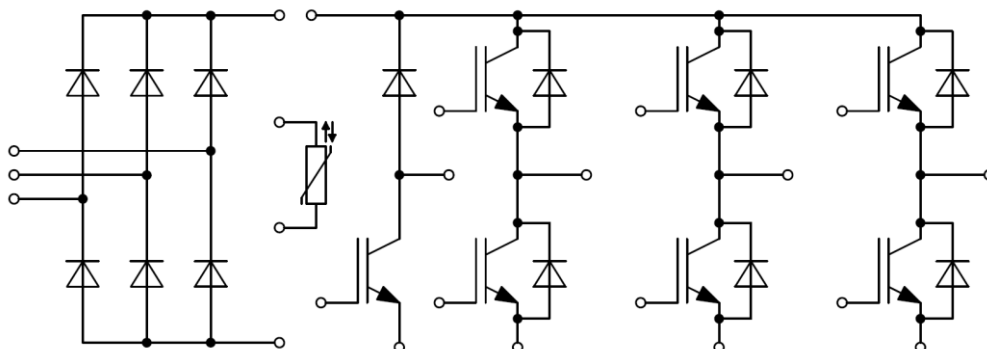
Features

- Low $V_{CE(sat)}$ Trench IGBT technology
- Short circuit capability
- $V_{CE(sat)}$ with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated heatsink using DBC technology
- UL file number:E340089

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Equivalent Circuit Schematic



Absolute Maximum Ratings $T_H=25^{\circ}\text{C}$ unless otherwise noted**IGBT-inverter**

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_H=100^{\circ}\text{C}$	15	A
I_{CRM}	Repetitive Peak Collector Current $t_p=1\text{ms}$	30	A

Diode-inverter

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
I_F	Diode Continuous Forward Current	10	A
I_{FRM}	Repetitive Peak Forward Current $t_p=1\text{ms}$	20	A
I_{FSM}	Surge Forward Current $t_p=10\text{ms}$ @ $T_{vj}=125^{\circ}\text{C}$	62	A
	@ $T_{vj}=150^{\circ}\text{C}$	53	
I^2t	I^2t -value, $t_p=10\text{ms}$ @ $T_{vj}=125^{\circ}\text{C}$	19	A^2s
	@ $T_{vj}=150^{\circ}\text{C}$	14	

Diode-rectifier

Symbol	Description	Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage	1600	V
I_{FRMSM}	Maximum RMS Forward Current per Chip @ $T_H=100^{\circ}\text{C}$	25	A
I_{RMSM}	Maximum RMS Current at Rectifier Output @ $T_H=100^{\circ}\text{C}$	25	A
I_{FSM}	Surge Forward Current $t_p=10\text{ms}$ @ $T_{vj}=25^{\circ}\text{C}$	300	A
	@ $T_{vj}=150^{\circ}\text{C}$	245	
I^2t	I^2t -value, $t_p=10\text{ms}$ @ $T_{vj}=25^{\circ}\text{C}$	450	A^2s
	@ $T_{vj}=150^{\circ}\text{C}$	300	

IGBT-brake

Symbol	Description	Value	Unit
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_C	Collector Current @ $T_H=100^{\circ}\text{C}$	15	A
I_{CRM}	Repetitive Peak Collector Current $t_p=1\text{ms}$	30	A

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	@ $T_{vj}=150^{\circ}\text{C}$	53	
I^2t	I^2t -value, $t_p=10\text{ms}$ @ $T_{vj}=125^{\circ}\text{C}$	19	A^2s
	@ $T_{vj}=150^{\circ}\text{C}$	14	

Module

Symbol	Description	Value	Unit
T _{vjmax}	Maximum Junction Temperature(inverter,brake)	175	°C
	Maximum Junction Temperature (rectifier)	150	
T _{vjop}	Operating Junction Temperature(inverter,brake)	-40 to +175	°C
	Operating Junction Temperature(rectifier)	-40 to +150	
T _{STG}	Storage Temperature Range	-40 to +125	°C
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1 min	2500	V
d _{Creep}	Terminal to Heatsink	11.5	mm
	Terminal to Terminal	6.30	
d _{Clear}	Terminal to Heatsink	10.0	mm
	Terminal to Terminal	5.00	
CTI	Comperative Tracking Index	> 175	
RTI	RTI Elec. Housing	120	°C
Internal Isolation	Basic Insulation (class 1,IEC 61140)	Al ₂ O ₃	

Note: T_{vjop} > 150°C is allowed for operation at overload conditions.

IGBT-inverter Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		1.50	1.95	V
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=125^{\circ}\text{C}$		1.70		
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}$		1.80		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.30\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	5.4	6.2	7.0	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			50	μA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			100	nA
R_{Gint}	Internal Gate Resistance			0		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		1.33		nF
C_{res}	Reverse Transfer Capacitance			0.01		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.10		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=25^{\circ}\text{C}$		27		ns
t_r	Rise Time			18		ns
$t_{d(off)}$	Turn-Off Delay Time			189		ns
t_f	Fall Time			193		ns
E_{on}	Turn-On Switching Loss			0.74		mJ
E_{off}	Turn-Off Switching Loss			1.10		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=125^{\circ}\text{C}$		27		ns
t_r	Rise Time			21		ns
$t_{d(off)}$	Turn-Off Delay Time			234		ns
t_f	Fall Time			285		ns
E_{on}	Turn-On Switching Loss			1.00		mJ
E_{off}	Turn-Off Switching Loss			1.50		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=150^{\circ}\text{C}$		27		ns
t_r	Rise Time			21		ns
$t_{d(off)}$	Turn-Off Delay Time			244		ns
t_f	Fall Time			294		ns
E_{on}	Turn-On Switching Loss			1.08		mJ
E_{off}	Turn-Off Switching Loss			1.57		mJ
I_{SC}	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}, V_{CC}=800\text{V}, V_{CEM} \leq 1200\text{V}$		45		A

Diode-inverter Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$		1.60	2.05	V
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=125^{\circ}\text{C}$		1.65		
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=150^{\circ}\text{C}$		1.65		
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=928\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=25^{\circ}\text{C}$		1.30		μC
I_{RM}	Peak Reverse Recovery Current			18		A
E_{rec}	Reverse Recovery Energy			0.50		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=800\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=125^{\circ}\text{C}$		2.14		μC
I_{RM}	Peak Reverse Recovery Current			18		A
E_{rec}	Reverse Recovery Energy			0.89		mJ
Q_r	Recovered Charge	$V_R=600\text{V}, I_F=15\text{A},$ $-di/dt=784\text{A}/\mu\text{s}, L_S=35\text{nH},$ $V_{GE}=-15\text{V}, T_{vj}=150^{\circ}\text{C}$		2.46		μC
I_{RM}	Peak Reverse Recovery Current			19		A
E_{rec}	Reverse Recovery Energy			1.03		mJ

Diode-rectifier Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=15\text{A}, V_{GE}=0\text{V}, T_{vj}=150^{\circ}\text{C}$		0.85		V
I_R	Reverse Current	$T_{vj}=150^{\circ}\text{C}, V_R=1600\text{V}$			3.0	mA

IGBT-brake Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		1.50	1.95	V
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=125^{\circ}\text{C}$		1.70		
		$I_C=15\text{A}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}$		1.80		
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.30\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	5.4	6.2	7.0	V
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			50	μA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			100	nA
R_{Gint}	Internal Gate Resistance			0		Ω
C_{ies}	Input Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		1.33		nF
C_{res}	Reverse Transfer Capacitance			0.01		nF
Q_G	Gate Charge	$V_{GE}=-15\dots+15\text{V}$		0.10		μC
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=25^{\circ}\text{C}$		27		ns
t_r	Rise Time			18		ns
$t_{d(off)}$	Turn-Off Delay Time			189		ns
t_f	Fall Time			193		ns
E_{on}	Turn-On Switching Loss			0.74		mJ
E_{off}	Turn-Off Switching Loss			1.10		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=125^{\circ}\text{C}$		27		ns
t_r	Rise Time			21		ns
$t_{d(off)}$	Turn-Off Delay Time			234		ns
t_f	Fall Time			285		ns
E_{on}	Turn-On Switching Loss			1.00		mJ
E_{off}	Turn-Off Switching Loss			1.50		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=15\text{A}, R_G=20\Omega, L_S=35\text{nH}, V_{GE}=\pm 15\text{V}, T_{vj}=150^{\circ}\text{C}$		27		ns
t_r	Rise Time			21		ns
$t_{d(off)}$	Turn-Off Delay Time			244		ns
t_f	Fall Time			294		ns
E_{on}	Turn-On Switching Loss			1.08		mJ
E_{off}	Turn-Off Switching Loss			1.57		mJ
I_{SC}	SC Data	$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}, T_{vj}=150^{\circ}\text{C}, V_{CC}=800\text{V}, V_{CEM} \leq 1200\text{V}$		45		A

Diode-brake Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V_F	Diode Forward Voltage	$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$		1.60	2.05	V
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=125^{\circ}\text{C}$		1.65		
		$I_F=10\text{A}, V_{GE}=0\text{V}, T_{vj}=150^{\circ}\text{C}$		1.65		

NTC Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
R_{25}	Rated Resistance			5.0		k Ω
$\Delta R/R$	Deviation of R_{100}	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
P_{25}	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

Module Characteristics $T_H=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
L_{CE}	Stray Inductance		30		nH
$R_{CC'+EE'}$ $R_{AA'+CC'}$	Module Lead Resistance, Terminal to Chip		8.00 6.00		m Ω
R_{thJH}	Junction-to-Heatsink (per IGBT-inverter)		1.436		K/W
	Junction-to-Heatsink (per Diode-inverter)		1.935		
	Junction-to-Heatsink (per Diode-rectifier)		1.212		
	Junction-to-Heatsink (per IGBT-brake)		1.436		
	Junction-to-Heatsink (per Diode-brake)		2.330		
F	Mounting Force Per Clamp	20		50	N
G	Weight of Module		24		g

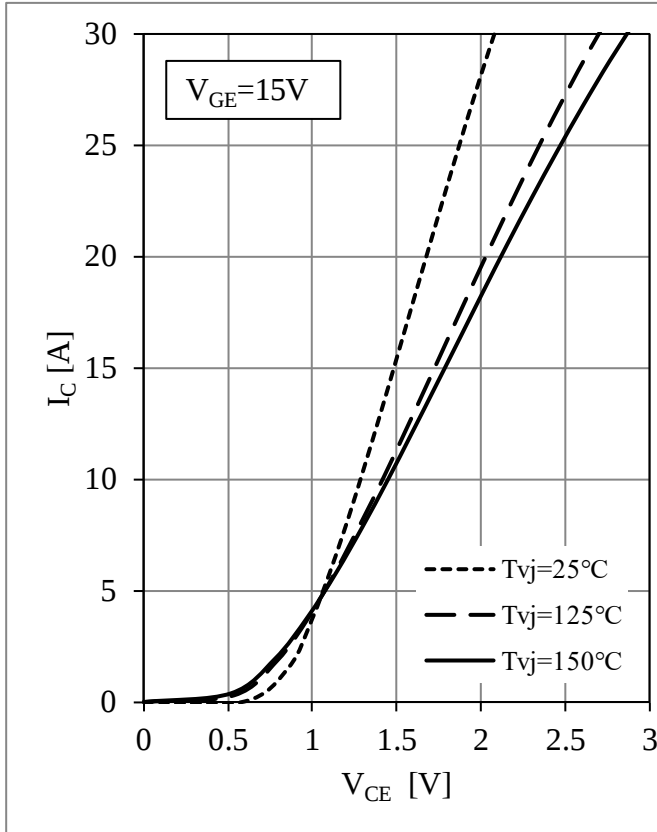


Fig 1. IGBT-inverter Output Characteristics

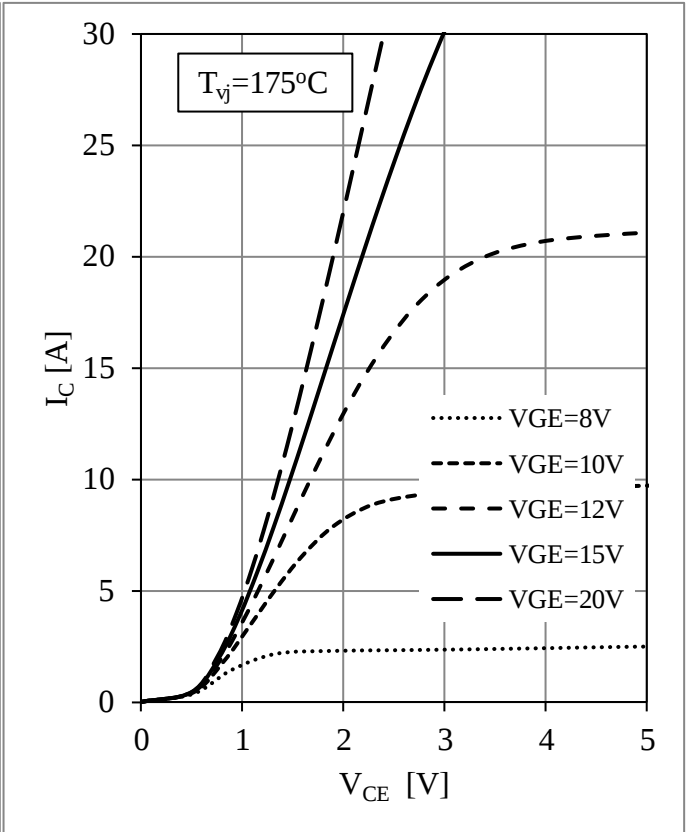


Fig 2. IGBT-inverter Output Characteristics

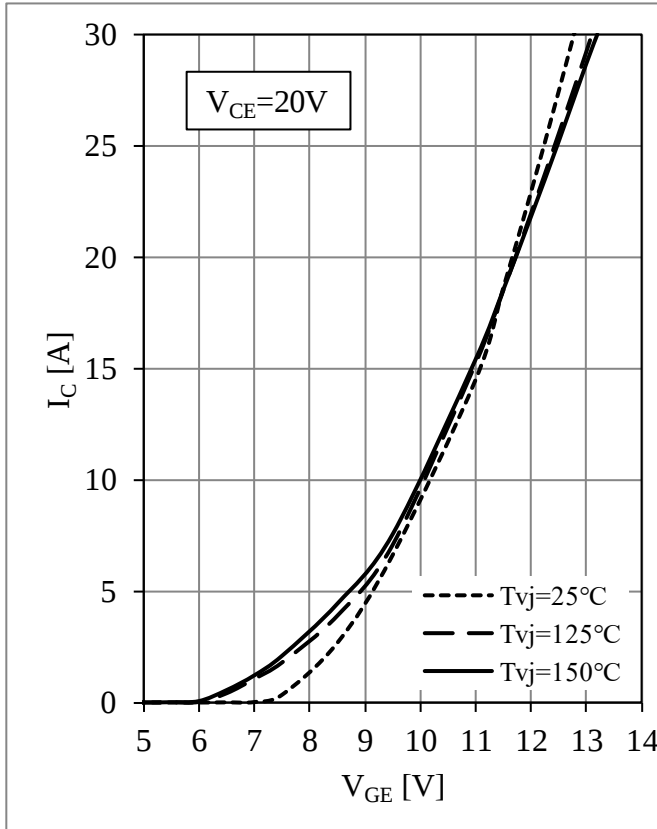
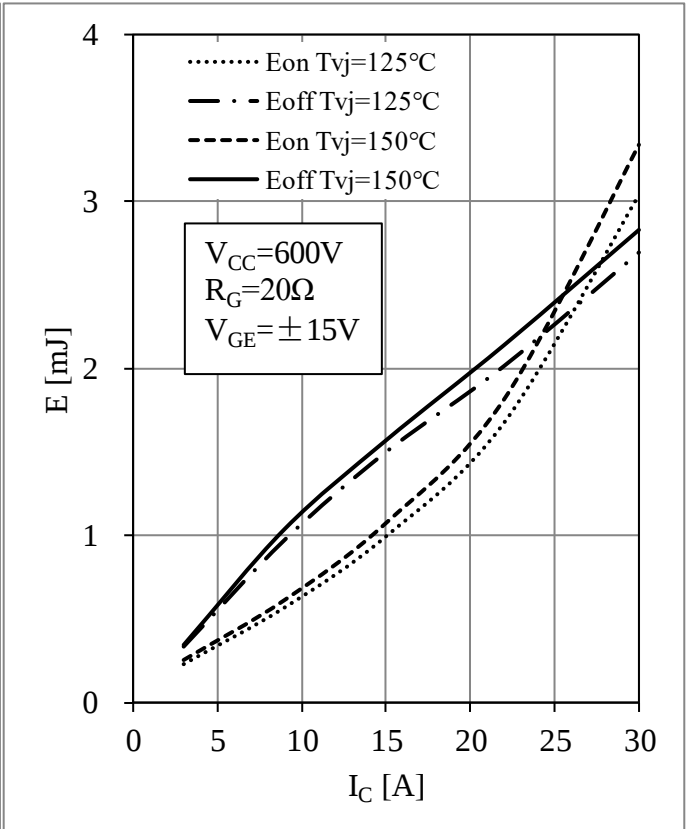


Fig 3. IGBT-inverter Transfer Characteristics

Fig 4. IGBT-inverter Switching Loss vs. I_C

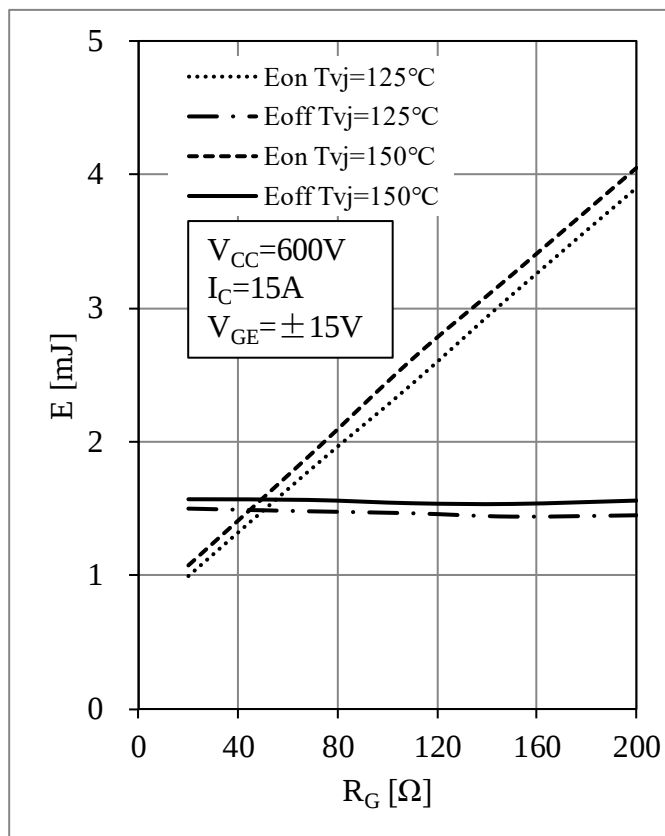
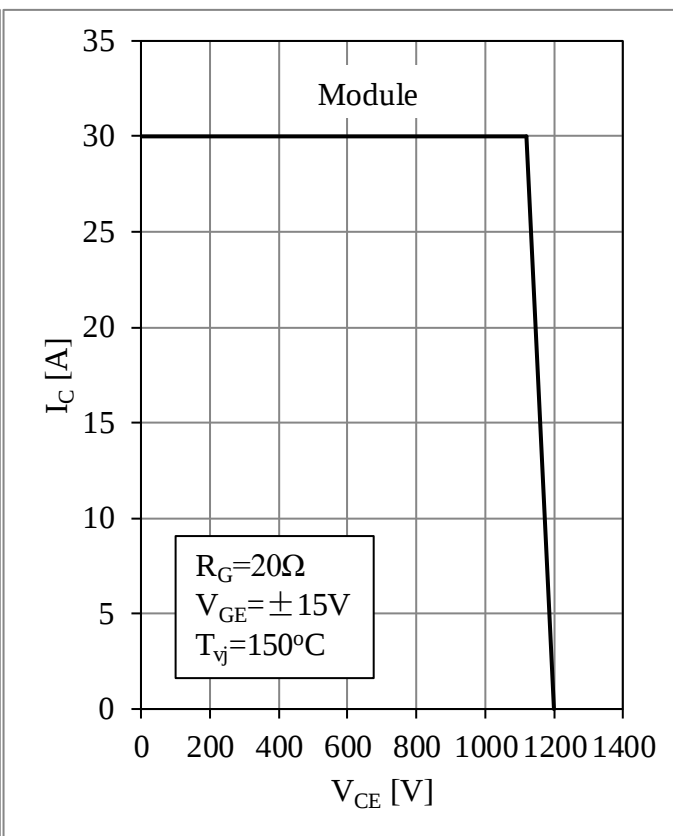
Fig 5. IGBT-inverter Switching Loss vs. R_G 

Fig 6. IGBT-inverter RBSOA

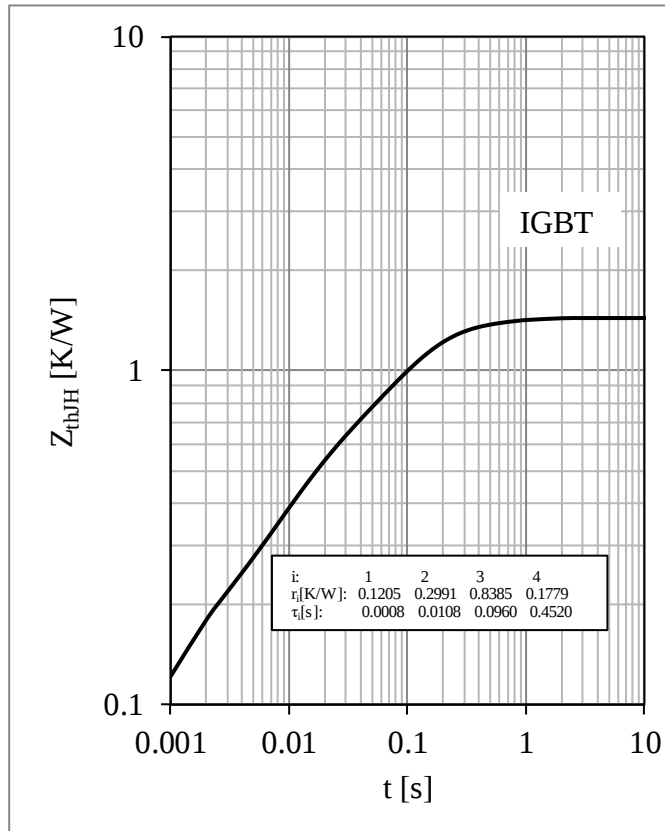


Fig 7. IGBT-inverter Transient Thermal Impedance

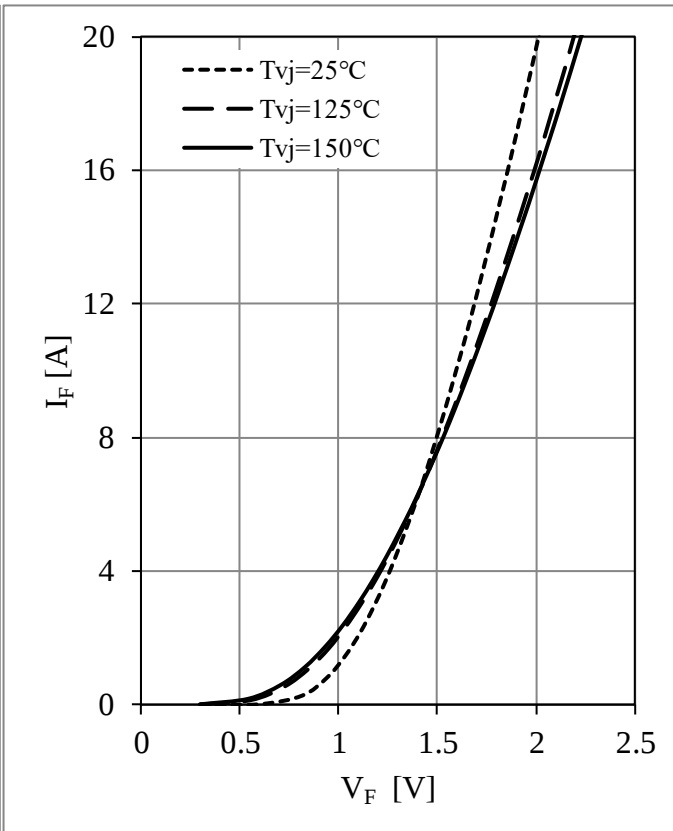


Fig 8. Diode-inverter Forward Characteristics

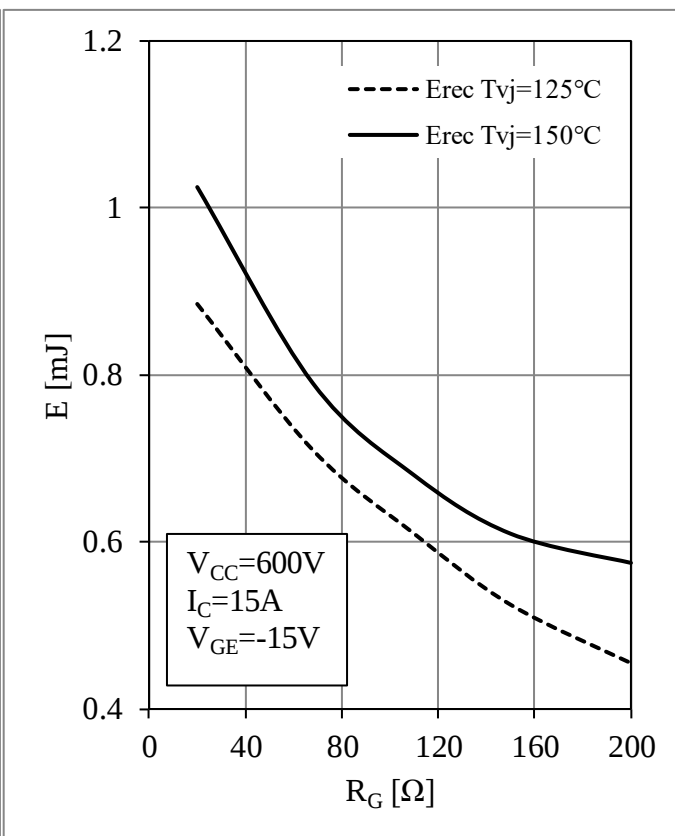
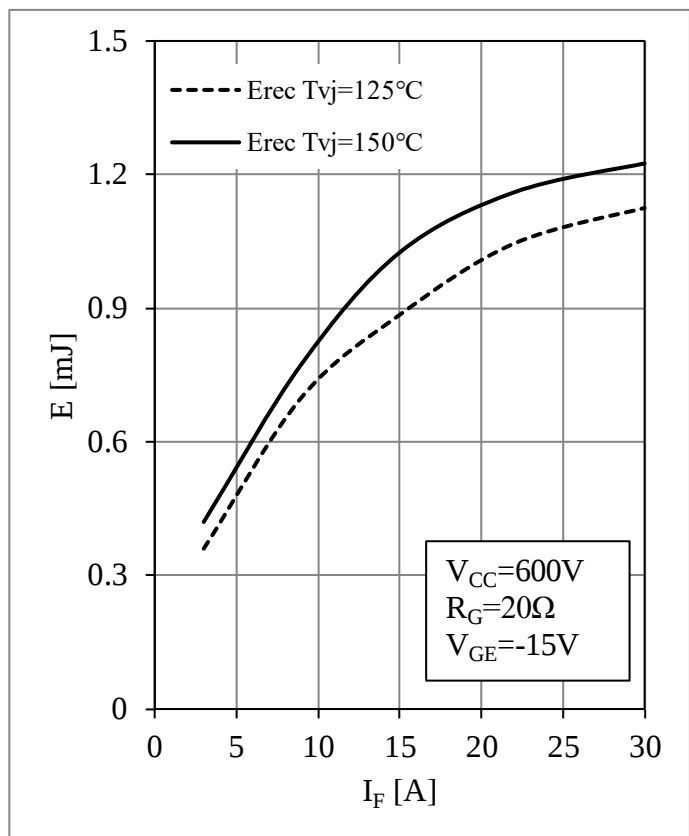
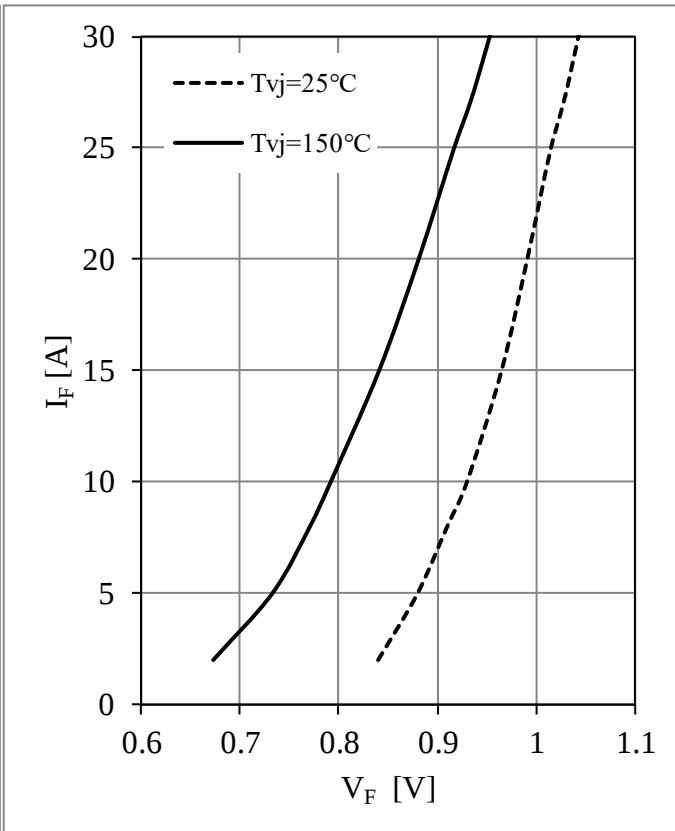
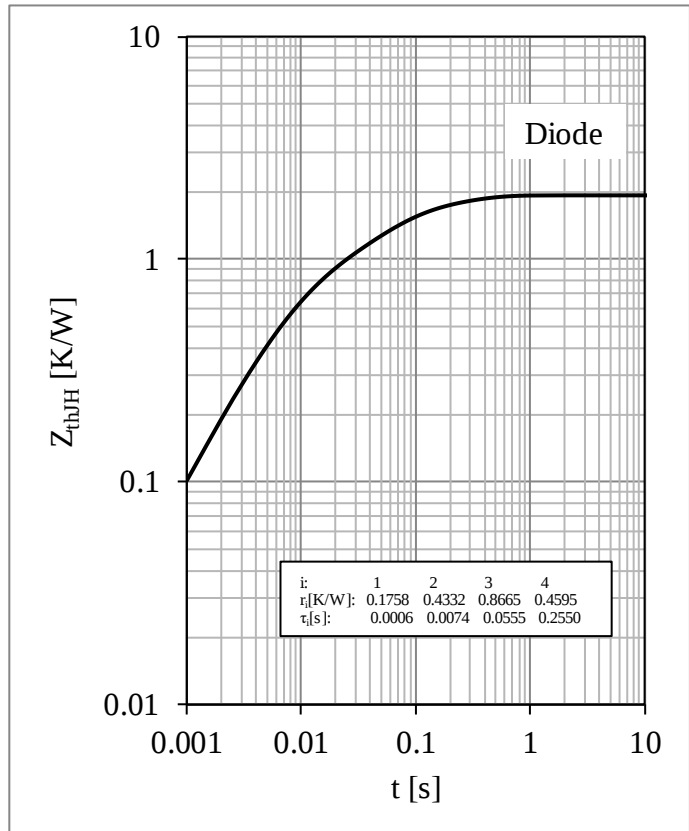
Fig 9. Diode-inverter Switching Loss vs. I_F Fig 10. Diode-inverter Switching Loss vs. R_G 

Fig 11. Diode-inverter Transient Thermal Impedance Fig 12. Diode-rectifier Forward Characteristics

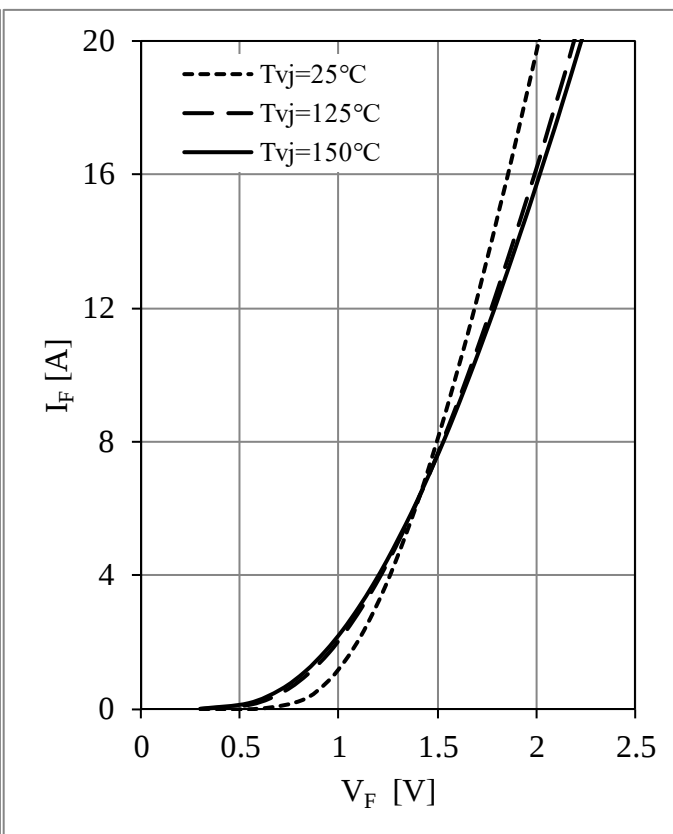
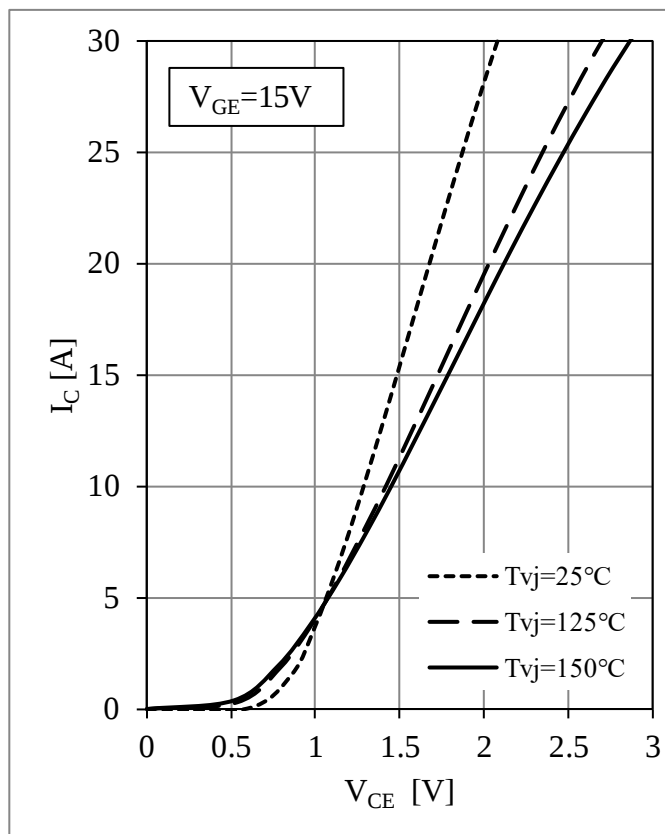


Fig 13.IGBT-brake-chopper Output Characteristics Fig 14.Diode-brake-chopper Forward Characteristics

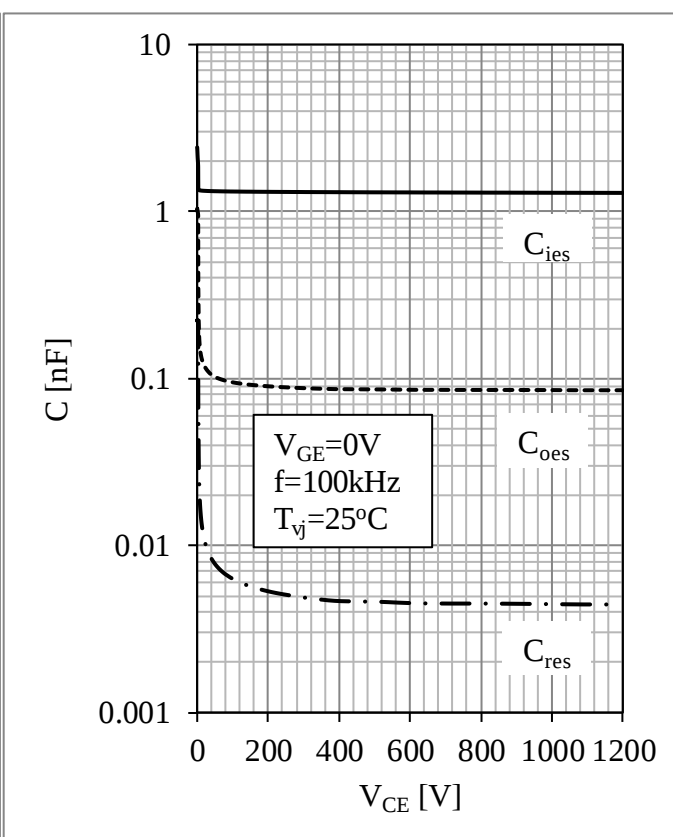
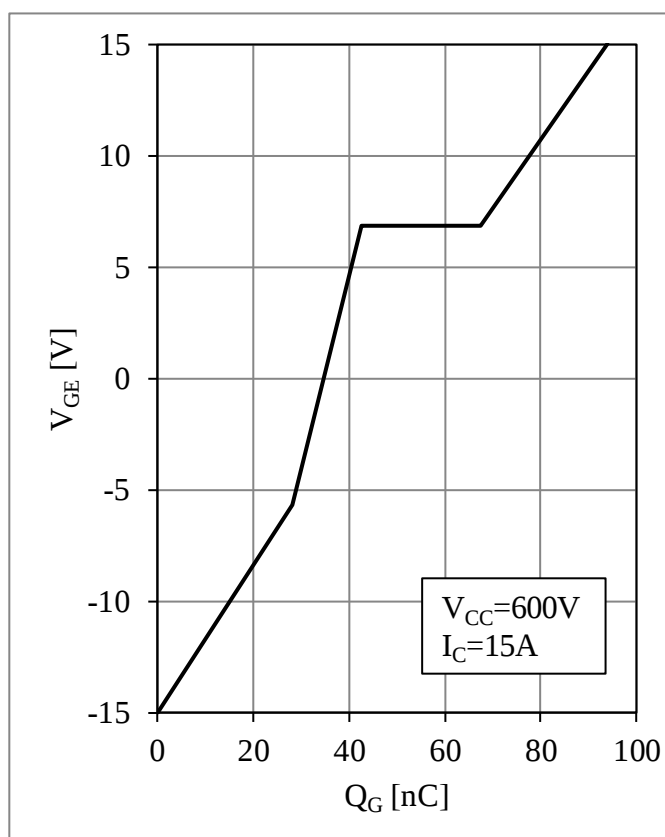


Fig 15. IGBT-inverter Gate Charge Characteristic Fig 16. IGBT-inverter Capacity Characteristic

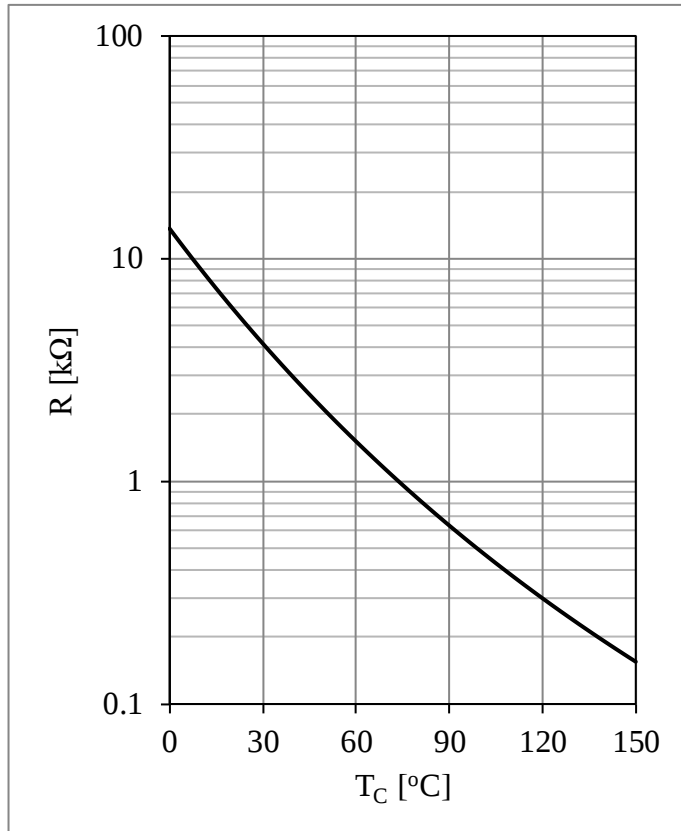
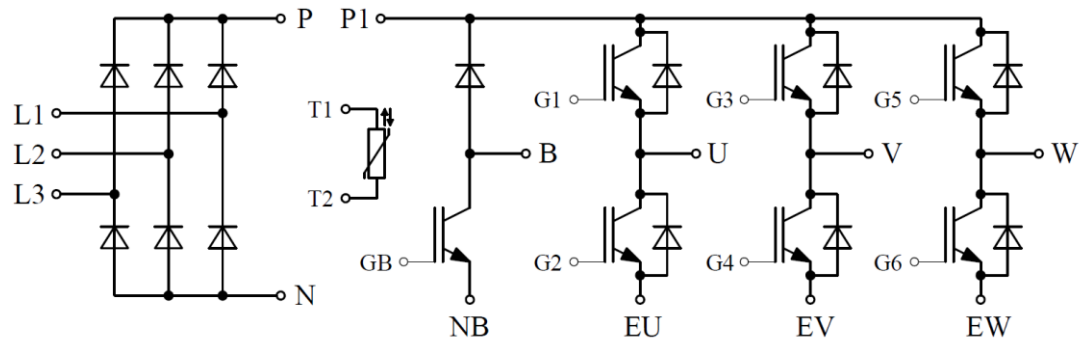


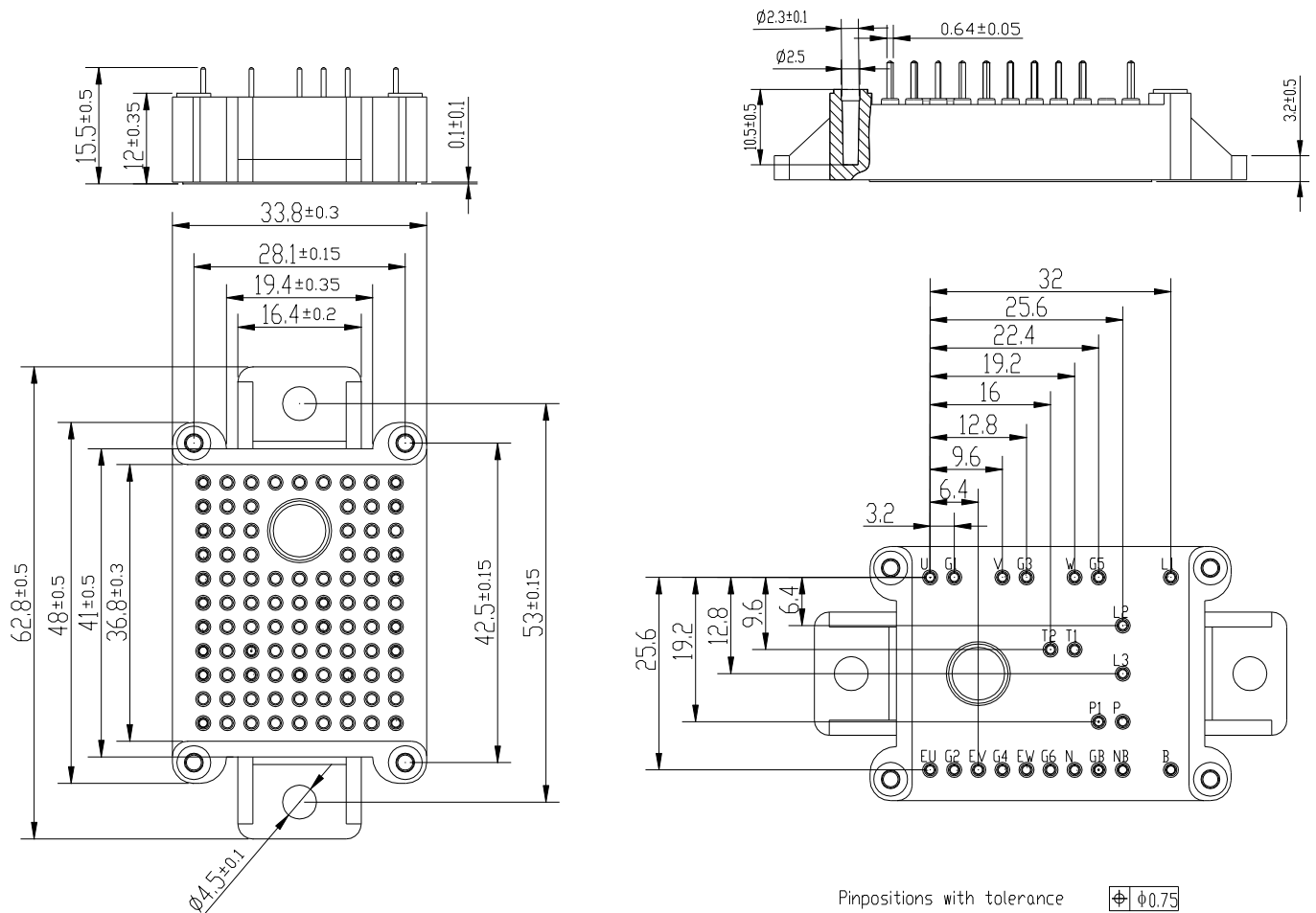
Fig 17. NTC Temperature Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



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